

75 Ω to 75 Ω Balanced

Ultra Low Profile 0805 Balun

Xinger.

Description:

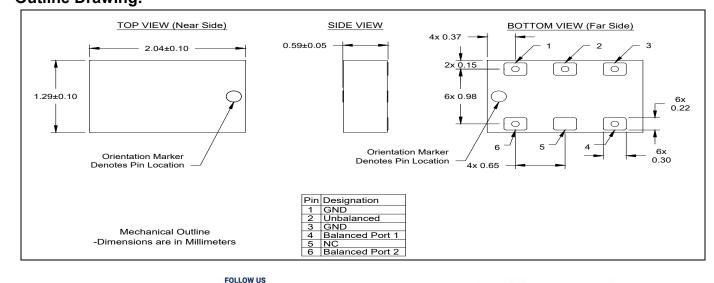
The B0922J7575A50HF is a low cost, low profile sub-miniature unbalanced to balanced transformer designed for differential inputs and output locations on modern chipsets in an easy to use surface mount package covering dual polarized commercial Satellite bands 950 MHz –1450 MHz & 1650 MHz – 2150 MHz. The B0922J7575A50HF is ideal for high volume manufacturing and delivers higher performance than traditional wire wound baluns. The B0922J7575A50HF has an unbalanced port impedance of 75 Ω and a 75 Ω balanced port impedance*. This transformation enables single ended signals to be applied to differential ports on modern integrated chipsets. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The B0922J7575A50HF is available on tape and reel for pick and place high volume manufacturing

Detailed Electrical Specifications:

Specification subject to change without notice

		ROOM (25°C)			
<u>Features:</u>	Parameter	Min.	Тур.	Max	Unit
• 950 – 2150 MHz	Frequency	950		2150	MHz
0.6mm Height Profile	Unbalanced Port Impedance		75		Ω
• 75 Ohm to 2 x 37.5 Ohm	Balanced Port Impedance		75		Ω
Low Insertion Loss	Return Loss	12	15		dB
Sat LNB Chipset Compliant		12			
 Input to Output DC Isolation Surface Mountable 	Insertion Loss*		0.8	1.1	dB
 Tape & Reel 	Amplitude Balance		1.0	1.4	dB
Non-conductive Surface	Phase Balance		3	9	Degrees
 RoHS Compliant 	CMRR		25		dB
Halogen Free	Power Handling			2	Watts
U U	Operating Temperature	-55		+85	°C

*Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C **Outline Drawing:**



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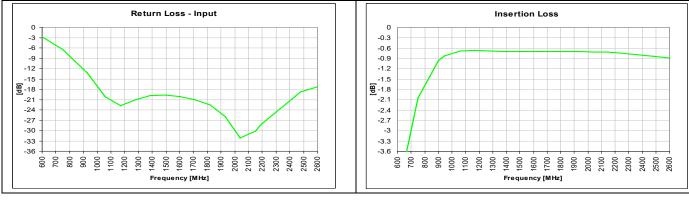
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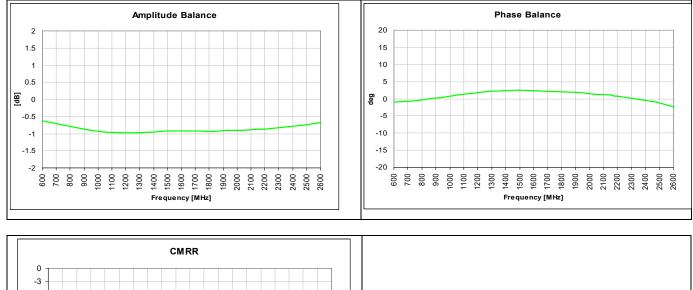
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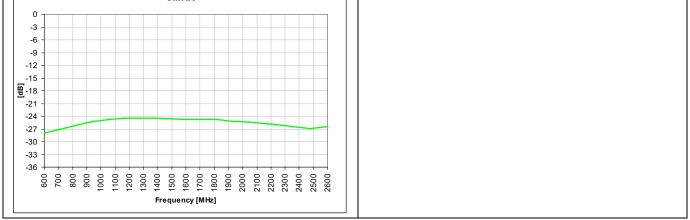


B0922J7575A50HF Rev C

Typical Performance: 600 MHz. to 2600 MHz.







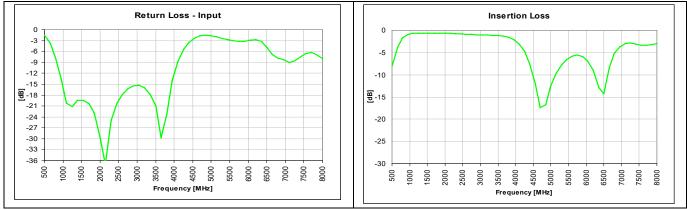
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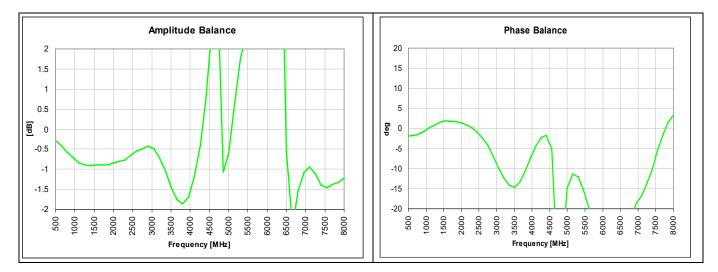
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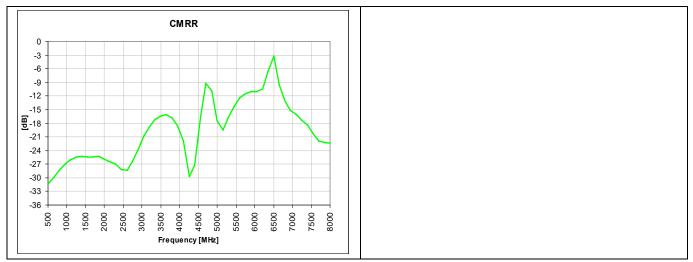
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Wide Band Performance:







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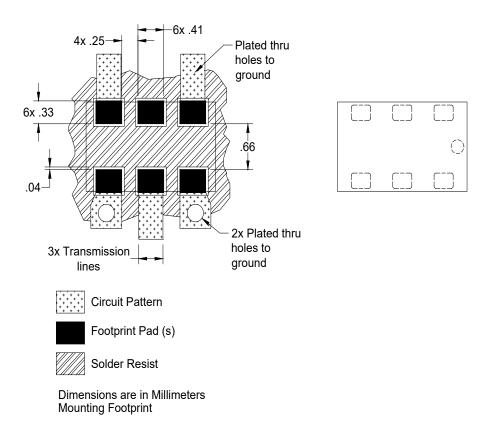


Mounting Configuration:

In order for Xinger surface mount components to work optimally, the proper impedance transmission lines must be used to connect to the RF ports. If this condition is not satisfied, insertion loss, Isolation and VSWR may not meet published specifications.

All of the Xinger components are constructed from organic PTFE based composites which possess excellent electrical and mechanical stability. Xinger components are compliant to a variety of ROHS and Green standards and ready for Pb-free soldering processes. Pads are Gold plated with a Nickel barrier.

An example of the PCB footprint used in the testing of these parts is shown below. In specific designs, the transmission line widths need to be adjusted to the unique dielectric coefficients and thicknesses as well as varying pick and place equipment tolerances.

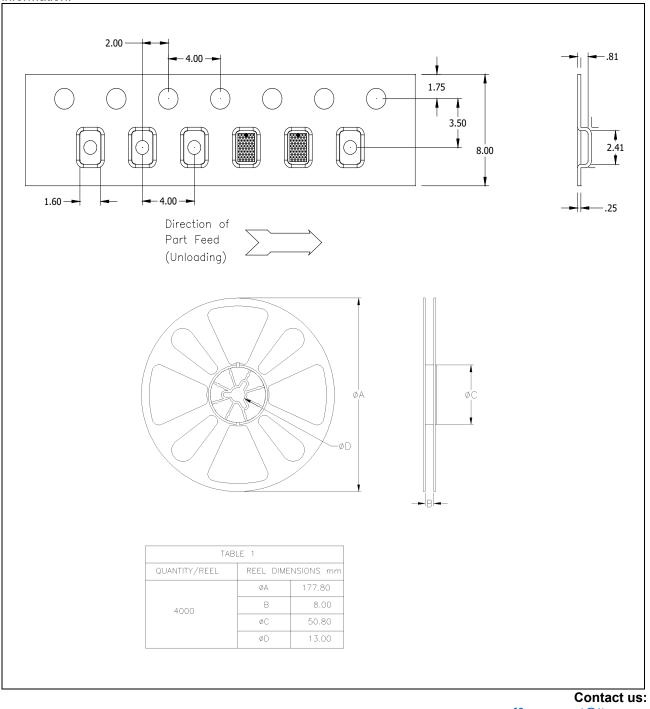






Packaging and Ordering Information:

Parts are available in reel and are packaged per EIA 481-2. Parts are oriented in tape and reel as shown below. Minimum order quantities are 4000 per reel. See Model Numbers below for further ordering information.



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